# onsemi

# **MOSFET** - Power, Single N-Channel, SO-8FL

30 V, 2.1 mΩ, 136 A NTMFS4C03N

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Parar			Symbol	Value	Unit
Drain-to-Source Voltage		V <sub>DSS</sub>	30	V	
Gate-to-Source Voltage	Э		V <sub>GS</sub>	±20	V
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 3)	Steady	$T_{C} = 25^{\circ}C$	۱ <sub>D</sub>	136	A
Power Dissipation $R_{\theta JC}$ (Notes 1, 3)	State	T <sub>C</sub> = 25°C	PD	64	W
Continuous Drain Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady	T <sub>A</sub> = 25°C	Ι <sub>D</sub>	30	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2, 3)	State	$T_A = 25^{\circ}C$	PD	3.1	W
Pulsed Drain Current	$T_A = 25^{\circ}C$ , $t_p = 1$ ms		I <sub>DM</sub> 500		А
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C	
Source Current (Body Diode)		I <sub>S</sub>	53	А	
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 11 A)		E <sub>AS</sub>	549	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

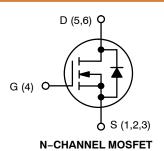
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	1.95	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40	

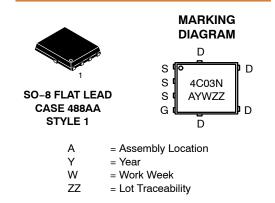
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
30 V	2.1 mΩ @ 10 V	100 4
30 V	2.8 mΩ @ 4.5 V	136 A





## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTMFS4C03NT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel

#### DISCONTINUED (Note 1)

NTMFS4C03NT3G	SO-8FL (Pb-Free)	5000 / Tape & Reel
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†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

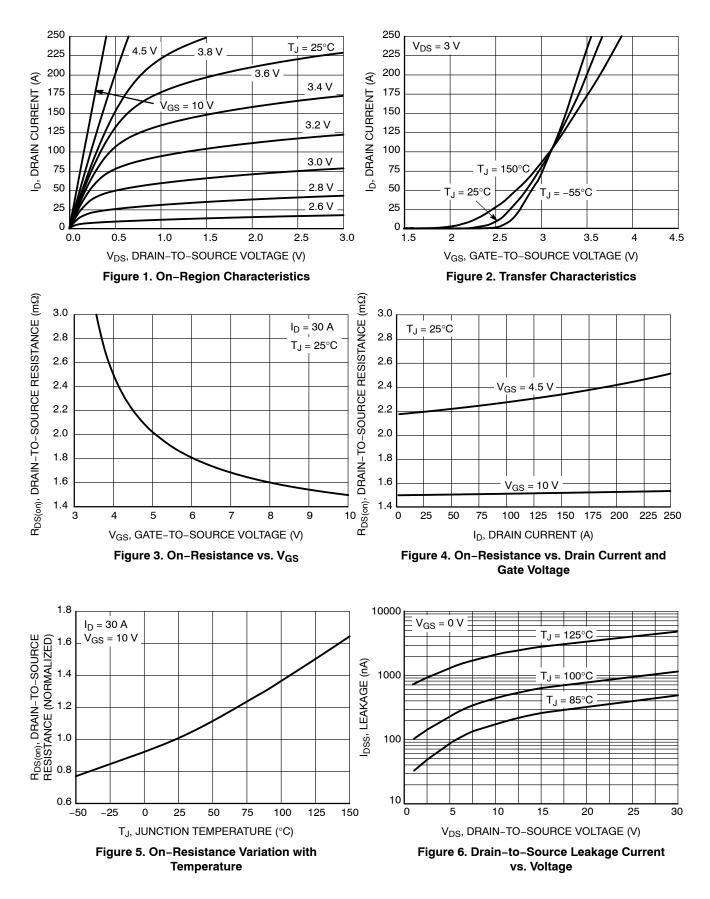
 DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

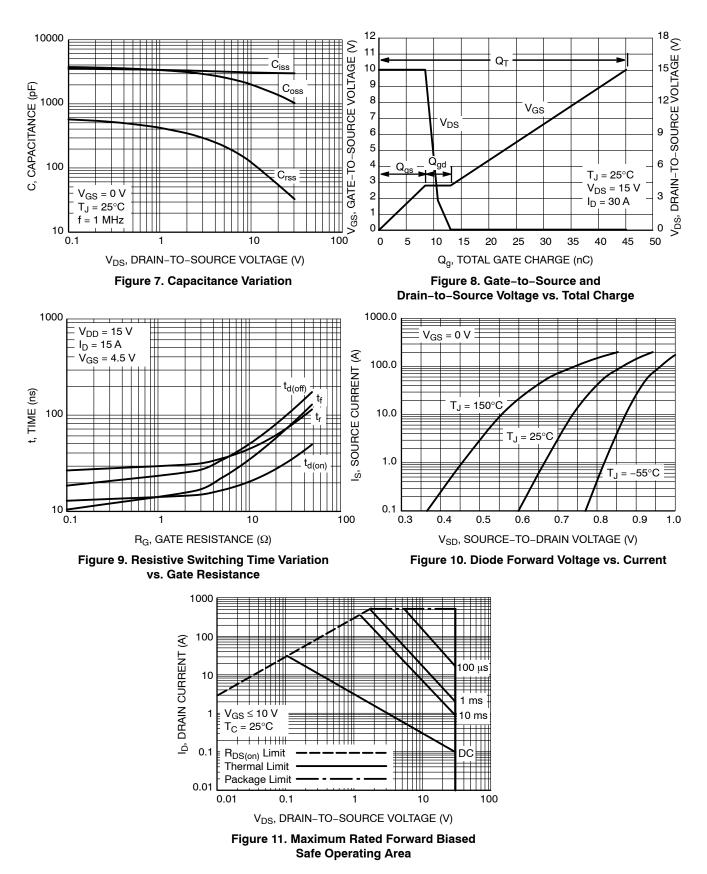
Parameter	Symbol	Test Cond	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D$	= 250 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				18.2		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 24 V	T <sub>J</sub> = 25 °C			1	μΑ
			T <sub>J</sub> = 125°C			10	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>G</sub>	<sub>iS</sub> = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub>	= 250 μA	1.3		2.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				4.8		mV/°0
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A		1.5	2.1	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 30 A		2.2	2.8	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub>	<sub>0</sub> = 30 A		136		S
Gate Resistance	R <sub>G</sub>	T <sub>A</sub> = 25	°C		1.0		Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>				3071		
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 15 V			1673		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				67		
Total Gate Charge	Q <sub>G(TOT)</sub>				20.8		
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			4.9		nC
Gate-to-Source Charge	Q <sub>GS</sub>				8.5		
Gate-to-Drain Charge	Q <sub>GD</sub>				4.7		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 15 V, I <sub>D</sub> = 30 A			45.2		nC
SWITCHING CHARACTERISTICS (Note 5)		•					
Turn-On Delay Time	t <sub>d(ON)</sub>				14		
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> =	15 V, I <sub>D</sub> = 15 A,		32		1
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$R_{\rm G} = 3.0 \Omega$			27		- ns
Fall Time	t <sub>f</sub>				17		
DRAIN-SOURCE DIODE CHARACTERISTIC	S	•					
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.75	1.1	V
		$I_{\rm S} = 10$ A	T <sub>J</sub> = 125°C		0.6		
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 30 A			47		
Charge Time	ta				23		ns
Discharge Time	t <sub>b</sub>				24		1
Reverse Recovery Charge	Q <sub>RR</sub>				39		nC

performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

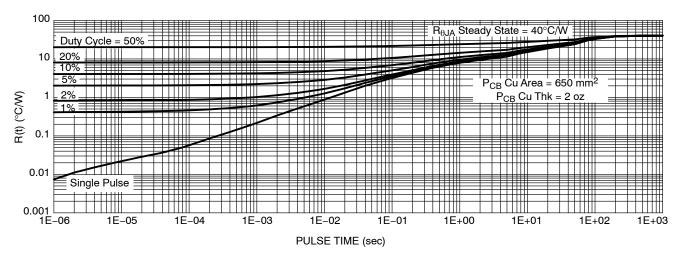
#### **TYPICAL CHARACTERISTICS**



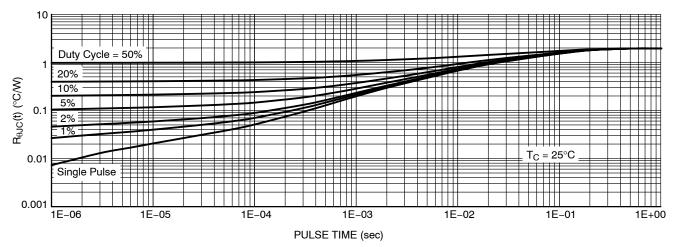
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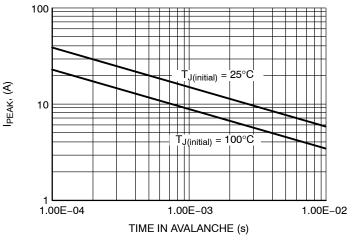


Figure 14. Avalanche Characteristics

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